High mobility epitaxial graphene devices via aqueous-ozone processing

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We find that monolayer epitaxial graphene devices exposed to aggressive aqueous-ozone processing and annealing became cleaner from post-fabrication organic resist residuals and, significantly, maintain their high carrier mobility. Additionally, we observe a decrease in carrier density from inherent strong n-type doping to extremely low p-type doping after processing. This transition is explained to be a consequence of the cleaning effect of aqueous-ozone processing and annealing, since the observed removal of resist residuals from SiC/G enables the exposure of the bare graphene to dopants present in ambient conditions. The resulting combination of charge neutrality, high mobility, large area clean surfaces, and susceptibility to environmental species suggest this processed graphene system as an ideal candidate for gas sensing applications. © 2015 AIP Publishing LLC. [http://dx.doi.org/10.1063/1.4907947]

Graphene, a single atomic carbon layer, is exceptionally sensitive to the presence of chemical species at its surface. This inherent sensitivity of graphene offers the capability of detecting the presence of surface adsorbates, even single molecules, through changes in electronic properties. However, for graphene devices, this sensitivity also presents a challenge, since device performance and reproducibility are heavily influenced by both the chemical environment and by contaminant species at the graphene surface. In particular, residuals of organic polymeric species left over from resist-based lithography can limit surface sensitive applications as well as degrade electronic device performance by introducing inhomogeneous doping profiles and scattering. In addition, resist residuals are known to contribute to poor interfaces during device fabrication and inhibit nanoscale microscopy.

A common method for removing contaminants in semiconductor technology involves ozone, generated by irradiation of molecular oxygen with ultraviolet light (UV) to decompose organic molecules at the surface of electronic materials. Similar ozone-based methodologies involving graphene devices have resulted in an initial, unstable, p-type doping effect and subsequent decomposition of graphene. Alternative graphene-cleaning methods include current annealing and contact mode atomic force microscopy (AFM), however, these are unsuitable for wafer-scale applications. A promising route for ensuring a clean post-fabrication graphene surface is to employ specific polymer resists, followed by high temperature thermal annealing. Although this method is compatible with wafer scale processing, its impact on electronic transport properties of graphene, such as carrier mobility and concentration, has not been reported.

In this study, we have investigated the effect of an aqueous-ozone based protocol on the surface morphology and transport properties of epitaxial graphene devices on silicicon carbide (SiC/G). The aggressive process, that involves immersing graphene samples in an aqueous solution of ozone followed by thermal annealing in ultrahigh vacuum (UHV), has been observed to attack silica glass and Si/SiO2 substrates and requires a custom teflon reaction vessel. Yet, aqueous-ozone processing has previously been shown to be compatible with SiC/G by means of surface characterisation techniques, in contrast to in situ generated ozone gas that damages graphene devices. Using AFM and temperature dependant magnetotransport, we found that monolayer epitaxial graphene devices exposed to the aggressive chemical environment became cleaner from post-fabrication organic resist residuals. Significantly, aqueous-ozone treated SiC/G devices maintained their electronic transport performance, in terms of carrier mobility, and display a decrease in carrier density from inherent n-type doping (specific to SiC/G) to extremely low p-type doping after processing.

We studied Hall bar devices on SiC/G grown on Si-face of 4H-SiC at T = 2000 °C and P = 1 atm Ar (Graphensic AB). Devices with dimensions W = 10 μm × L = 24 μm were patterned on SiC/G using standard electron-beam lithography, lift-off, and oxygen plasma etching. After patterning, the samples were encapsulated in PMMA resist to preserve the doping level and enable initial electrical characterization of the material in terms of carrier density and mobility before being washed in acetone and isopropanol. Following initial characterization, the samples were immersed in a Teflon vessel containing deionized water into which ozone, generated ex situ in a molecular oxygen gas stream, was bubbled through the reaction vessel for 3 min prior to rinsing the devices in deionized water and vacuum-drying (1 millibar, 60 °C). The samples were then annealed (500 °C) in either UHV (sample A, 60 min) or an inert gas atmosphere (sample B, 10 min) before further surface and magnetotransport measurements.

Surface characterization of SiC/G by AFM revealed that the process has a cleaning effect on the samples, by

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removing resist residuals present on the graphene surface after microfabrication. Figure 1(a) shows a SiC/G Hall bar device (sample A) after processing. The topography of the sample, as shown by height AFM, indicates substantial cleaning to the graphene surface. In particular, the bare SiC and bilayer graphene regions (dark height contrast, confirmed by optical microscopy) exhibit a very sparse coverage of resist residuals remaining at the surface.

In order to discern the cleaning contribution of each process step, we used AFM to study the topography before and after aqueous-ozone processing and then subsequently after rapid thermal annealing in an argon atmosphere (sample B). Before processing, AFM scans after conventional acetone/isopropanol solvent washing (Figure 1(b)) indicated that several nanometers of resist residuals remained on the graphene surface. Subsequent aqueous-ozone processing (3 min) resulted in uneven cleaning, with resist residuals preferentially removed from bilayer graphene (Figure 1(c)). However, some contamination still remained on the graphene surface. After rapid thermal annealing in argon (10 min, 500 °C) the majority of resist residuals were removed and a significantly cleaner surface was exhibited (Figure 1(d)). The resulting surface of sample B closely resembled that of sample A, annealed under UHV.

The removal of resist residuals using these cleaning methods was found to be most effective for bare SiC and bilayer graphene. In contrast to this observation, mechanical cleaning by contact mode AFM preferentially cleans monolayer and bilayer graphene domains, but is less effective at removing resist from bare SiC. This suggests a lower binding energy on SiC and bilayer graphene than for monolayer, but a lower translational barrier on the graphene surface in comparison to the bare SiC surface.

Together with the cleaning effect on the surface of SiC/G, we observed a transition from n-type to low p-type doping and preservation of the carrier mobility after the aqueous-ozone treatment. As-grown SiC/G samples are systematically measured by angle-resolved photoemission spectroscopy (ARPES) to exhibit strong n-type doping on the order of 10^13 electrons cm^-2 under UHV conditions. The origin of this intrinsic heavy n-doping is the electrostatic interaction between graphene and the SiC substrate via the buffer layer. However, when encapsulated with polymer resist the Hall carrier density is measured to be 3–8 x 10^12 electrons cm^-2, depending on the proportion of monolayer and bilayer graphene present in the device.

In this study, all polymer encapsulated devices exhibited n-type doping, obtained by low-field Hall measurements as n = 1/εRH = 1/(eνx/Rxy) ≈ 4 x 10^12 electrons cm^-2 and Hall mobility, estimated as μ = ρxy/Rxy ≈ 1500 cm^2 Vs^-1 at room temperature (sample A). After processing, magnetotransport measurements revealed a change of sign in the Hall coefficient, signalling a transition from electron to p-type doping at the level of p = 4.6 x 10^10 holes cm^-2 whilst the Hall mobility was maintained above 1400 cm^2 Vs^-1, also at room temperature. An overview of the graphene carrier density throughout all processing steps presented in this study is shown in Figure 2(a).

The high quality and electronic integrity of the processed device were revealed from low temperature magnetotransport measurements, by a Hall mobility of μ = 11 000 cm^2 V^-1 s^-1 and extremely low carrier density of p = 4 x 10^10 holes cm^-2 at liquid helium temperature (Figure 2(b)). Subsequently, the quantum Hall effect was observed for this device at magnetic fields as low as B = 2 T (Figure 2(c)). Hall plateau observed at Rxy = ±h/(2e^2), where h is the Planck constant and e is the elementary charge, are the fingerprint of monolayer graphene, confirming that charge transport in the processed SiC/G is dominated by monolayer graphene, thus ruling out intercalation of chemical species at the graphene-SiC interface. This latter statement is supported by the strong temperature dependence of the carrier mobility, measured from room temperature down to 4 K (Figure 2(b)). In SiC/G, the graphene layer sits on top of an electrically insulating, graphene-like layer (buffer layer) chemically bonded to the SiC substrate. It has been shown that it is possible to decouple the buffer layer from the SiC substrate by intercalation of species such as hydrogen. In sharp contrast to our processed samples, intercalation results in a quasi-free-standing bilayer graphene on the surface of SiC, which displays temperature independent carrier mobility and QHE plateaux sequence for bilayer graphene.
As for the doping mechanism we infer, from the temperature dependence of mobility and Hall coefficient (Figure 2(b)), the presence of thermally activated charge carriers on the measured device. At low temperature, the p-type doping is found to be as low as $4 \times 10^{10}$ holes cm$^{-2}$. This exceptionally low value indicates a modification after processing to a very homogeneous, charge neutral graphene system. Above 2 K, the carrier density increased significantly due to thermal activation, reaching $\sim 5 \times 10^{11}$ holes cm$^{-2}$ at room temperature.

In light of the cleaning observations made during the AFM analysis, we considered that the p-type doping effect observed in these samples after processing was caused by the presence of ambient dopants at the surface of the graphene device, enabled by the removal of polymer resist. This effect is similar to that reported in measurements of bare-naked graphene exposed to ambient conditions.\cite{3Y. Dan, Y. Lu, N. J. Kybert, Z. Luo, and A. T. C. Johnson, Nano Lett. 15, 451 (2015)}\footnote{As a means to validate this hypothesis, we heated the measured device to 55 °C in a controlled gaseous helium environment, leading to a 47% decrease in resistivity (Figure 2(d)). Hall measurements after annealing revealed that the device had reverted to n-type doping, with a carrier density of $1.2 \times 10^{12}$ electrons cm$^{-2}$ (Figure 2(a)). We attributed this modification to labile atmospheric electron acceptors that were subsequently removed from the graphene surface by annealing.

In summary, we have evaluated the consequences of aqueous-ozone processing and annealing on monolayer graphene Hall bar devices on silicon carbide. We find that devices exposed to the aggressive aqueous-ozone environment became cleaner from post-fabrication organic resist residuals and, significantly, maintained their electronic transport performance in terms of carrier mobility. Quantum Hall effect measurements confirm that transport is dominated by monolayer graphene and, consequently, we rule out intercalation of species at the SiC-graphene interface. This is supported by strong temperature dependence of the carrier mobility indicating the preservation of a strong graphene-substrate interaction. The processed devices exhibit extremely low p-type doping, which is attributed to physisorbed ambient acceptors that gain access to the graphene surface due to the removal of resist residuals. The combination of low carrier density, high mobility, large area clean surfaces, and susceptibility to environmental species suggest this processed graphene system as an ideal candidate for gas sensing applications.

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